

JY8N5M

N Channel Enhancement Mode Power MOSFET

GENERAL DESCRIPTION

The product utilizes the advanced planar processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

FEATURES

- 500V/8A, $R_{DS(ON)} = 0.75\Omega$ @ $V_{GS} = 10V$ (Typical)
- Fast switching and reverse body recovery
- Excellent package for good heat dissipation

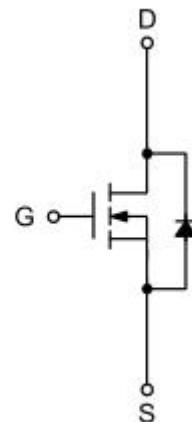
APPLICATIONS

- Lighting
- High efficiency switch mode power supplies

PIN DESCRIPTION



TO-252 -2L top view



JY8N5M

Absolute Maximum Ratings(Tc=25° C Unless Otherwise Noted)

Symbol	Parameter		Rating	Unit
V _{DS}	Drain-Source Voltage		500	V
V _{GS}	Gate-Source Voltage		±30	V
I _D	Continuous Drain Current	Tc=25° C	8	A
		Tc=100° C	4.8	
I _{DM}	Pulsed Drain Current		30	A
P _D	Maximum Power Dissipation		80	W
T _J T _{STG}	Operating Junction and Storage Temperature Range		-55 to +150	°C
R _{θJC}	Thermal Resistance-Junction to Case		1.56	°C/W

Electrical Characteristics(Tc=25° C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	500			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =500V, V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±30V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _{DS} =250uA	2.0		4.0	V
R _{DS(ON)}	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =4A		0.75	0.85	Ω

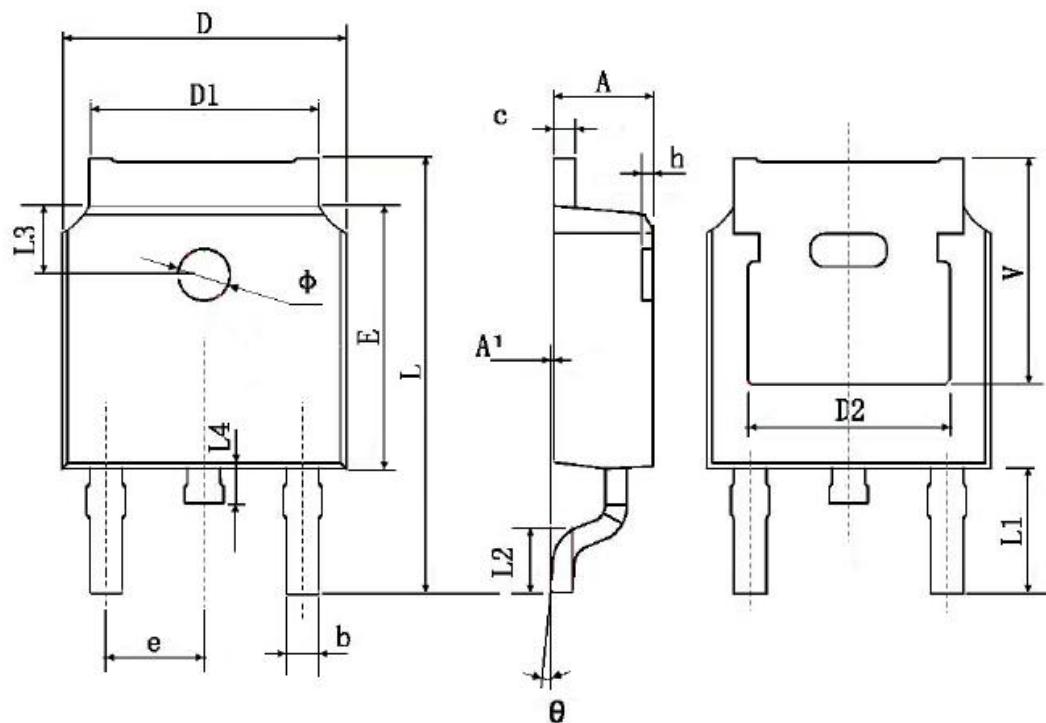
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Electrical Characteristics($T_c=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}, I_{SD}=4\text{A}$			1.4	V
Tr _r	Reverse Recovery Time	$I_{SD}=8\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$		390		ns
Q _{rr}	Reverse Recovery Charge			2.6		nC
Dynamic Characteristics						
$T_{d(on)}$	Turn-on Delay Time	$V_{DS}=250\text{V}, R_G=25\Omega, I_{DS}=8\text{A}, V_{GS}=10\text{V}$		16		ns
Tr	Turn-on Rise Time			12		
$T_{d(off)}$	Turn-off Delay Time			58		
T_f	Turn-off Fall Time			26		
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		795		pF
C_{oss}	Output Capacitance			68		
C_{RSS}	Reverse Transfer Capacitance			8.1		
Q_g	Total Gate Charge	$V_{DS}=400\text{V}, I_D=8\text{A}, V_{GS}=10\text{V}$		15.5		nC
Q_{gs}	Gate-Source Charge			4.6		
Q_{gd}	Gate-Drain Charge			4.1		

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TO-252 Package Outline



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A ¹	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	0.483 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	